Low Voltage Operation Omnipolar Detection

Type Hall Effect Switch IC

General Description

The ET3712A31 is a high sensitivity and high-accuracy Omnipolar Hall effect switch IC that operates at a low voltage and low current consumption. The output voltage will be pulled low when this IC detects the magnetic flux density is larger than operate point(B_{OPN}/B_{OPS}) and the output voltage will recover to high until the magnetic flux density is smaller than the release point(B_{RPN}/B_{RPS}). Using this IC with a magnet makes it possible to detect the open / close status in various applications.

To achieve a high-density mounting the ET3712A31 uses a super-small DFN4 package.

The ET3712A31 is suitable for battery powered portable devices such as mobile phones and portable PCs etc. due to its low voltage operation and low current consumption, the average current consumption is only typ. 12 μ A with a 1.85 V supply.

Features

- Pole detection: Omnipolar pole
- Output logic: Active low
- Output form: CMOS output, no external pull-up resistor required
- Operating Point: B_{OP} = 3.0 mT typ.
- Operating cycle: t_{CYCLE} = 5.70 ms typ.
- Current consumption: I_{DD} = typ. 12.0 µA at 1.85 V
- Power supply voltage range: V_{DD} = 1.6 V to 3.5 V
- Operation temperature range: $T_A = -40^{\circ}C$ to $+85^{\circ}C$
- Lead-free (Sn 100%), halogen-free
- Super small DFN4 package

Application

- Open/Close detection for flip mobile phones
- Smart cover for smart phones
- Smart cover for portable PCs, tablet PCs
- Digital video cameras and portable game consoles
- Home appliances

Pin Configuration



Pin Function

Pin No.	Pin Name	Pin Function
1	VDD	Power supply pin
2	VSS	Ground Pin
3	NC	No connection
4	OUT	Output pin

Block Diagram



Functional Description

Applied magnetic flux

The magnetic flux applied to ET3712A31 should on the vertical direction on marking surface. If not, the horizontal component has no effect to detection. ET3712A31 is omnipolar type detector, the output voltage (V_{OUT}) is inverted when the S or N type magnetic flux is applied to IC.

Below shows the direction in which magnetic flux should be applied.



Hall sensor Position

The Hall sensor embedded in ET3712A31 is at the center of IC. As show below, the position of this Hall sensor is located in the area indicated by a circle, the diameter size of which is about 0.3 mm.



Detecting Operation

ET3712A31 detects magnetic field periodically. When vertical component of the magnetic flux applied to IC exceeds the operating point (B_{OPN} or B_{OPS}) such as the S or N pole of a magnet is moved closer to IC, V_{OUT} changes from "H" to "L". On the contrary, if magnetic flux is lower than the release point (B_{RPN} or B_{RPS}), V_{OUT} changes from "L" to "H".



The relationship between the magnetic flux density and V_{OUT} is shown below.

Operating Current

ET3712A31 performs the intermittent operation, therefore the average current consumption depends on the current in active mode , the active period (t_{AW}), the current in sleep mode, and sleep period (t_{SL}). The active current is about 640 µA typically, and 0.72 µA at sleep mode. Please refer to electrical characteristic table for detail.

The time dependency of the current consumption is shown below.



Timing Diagram

The operation timing of this IC is shown below.



Absolute Maximum Ratings

	T - 105°C	unlogo	othonuing	onooifio	ግ/
(T _A = +25°C	uniess	otherwise	specifie	u)

Symbol	Parameters	Rating	Unit
V _{DD}	Power supply voltage	V _{SS} -0.3 ~ V _{SS} +7.0	V
IOUT	Output current	±1.0	mA
Vout	Output voltage	$V_{SS} - 0.3 \sim V_{DD} + 0.3$	V
TA	Operation ambient temperature	-40 ~ +85	°C
Tstg	Storage temperature	-40 ~ +125	°C
θ _{JA}	Junction-to-ambient thermal resistance	300	°C/W

Caution: The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

Electrical Characteristics

		V _	4 05 1		- 41		
($T_{A} = +25^{\circ}C,$	$v_{DD} =$	1.85 V	, uniess	otherwise	speciliea))

Symbol	Parameters	Conditions		Min	Тур	Max	Unit
Vdd	Power supply voltage	-		1.60	1.85	3.50	V
I _{DD}	Current consumption	Average Supply Current			12.0	22.0	μA
	Output voltage		Output transistor Nch,			0.4	V
Vout		CMOS output	Ι _{ΟυΤ} = 0.5mA				
VOUT			Output transistor Pch,	V _{DD} -0.4			V
			I _{OUT} = −0.5mA	VDD-0.4			v
taw	Awake mode time				0.10		ms
ts∟	Sleep mode time				5.60		ms
tcycle	Operating cycle				5.70	12.00	ms

Magnetic Characteristics

(T _A = +25°C, V _{DD} =	1.85 V, unless	otherwise spe	cified)
--	----------------	---------------	---------

Parameters	;	Symbol	Conditions	Min	Тур	Max	Unit
Operation point ⁽¹⁾	N pole	BOPN		2.0	3.0	4.0	mT ⁽⁴⁾
Operation point.	S pole	Bops		-4.0	-3.0	-2.0	mT
Release point ⁽²⁾	N pole	Brpn		1.8	2.2	3.7	mT
	S pole	Brps		-3.7	-2.2	-1.8	mT
Hysteresis width ⁽³⁾	N pole	B _{HN}	Bhn = Bopn - Brpn		0.8		mT
	S pole	B _{HS}	Bhs = Bops - Brps		0.8		mT

Notes:

(1) Operating points (B_{OPN}, B_{OPS}): B_{OPN} and B_{OPS} are the values of magnetic flux density triggers the output voltage (V_{OUT}) to low by increasing the N pole or S pole magnetic flux density applied to this IC. Even when the magnetic flux density is larger than B_{OPN} or B_{OPS}, V_{OUT} status is held.

(2) Release points (B_{RPN}, B_{RPS}): B_{RPN} and B_{RPS} are the values of magnetic flux density makes the output voltage (V_{OUT}) recover to high by decreasing the N pole or S pole magnetic flux density applied to this IC. Even when the magnetic flux density is lower than B_{RPN} or B_{RPS}, V_{OUT} status is held.

(3) Hysteresis widths (B_{HN}, B_{HS}): B_{HN} and B_{HS} are the difference between B_{OPN} and B_{RPN}, and B_{OPS} and B_{RPS}, respectively.

(4) The unit of magnetic density mT can be converted by using the formula 1 mT = 10 Gauss.

Application Circuit



Precautions

- The power supply for this IC should has low impedance, the IC may malfunction due to a supply voltage drop caused by feed through current.
- Power supply voltage rapidly changing may cause IC malfunction.
- Large stress on this IC may affect the magnetic characteristics. Avoid large stress applied to the IC on a board.

Package Dimension



Revision History and Checking Table

Version	Date	Revision Item	Modifier	Function & Spec Checking	Package & Tape Checking
1.0	2019-11-07	Initial Version	Chenh	Wanggp	Zhujl
1.1	2023.1.17	Update Typeset	Shib	Wanggp	Zhujl